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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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10/560,160

01/29/2007

Kenji Kohiro

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EXAMINER

NADAV, ORI

ART UNIT

PAPER NUMBER

2811

NOTIFICATION DATE

DELIVERY MODE

12/27/2010

ELECTRONIC

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

mailroom@bskb.com

Office Action Summary	Application No. 10/560,160	Applicant(s) KOHIRO ET AL.	
	Examiner Ori Nadav	Art Unit 2811	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 22 October 2010.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-7 and 9-18 is/are pending in the application.
- 4a) Of the above claim(s) 1-7 is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 9-18 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|---|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413) |
| 2) <input type="checkbox"/> Notice of Draftperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____ |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08) | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

Claims 10-17 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention. The claimed limitation of "wherein the InP buffer layer is grown on the InGaP buffer layer or InGaAsP buffer layer", as recited in claim 10, is unclear as to the structural relationship between and the InP buffer layer and the claimed compound semiconductor, since the InP buffer layer was not recited earlier in the claim.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 9 and 18 are rejected under 35 U.S.C. 102(e) as being anticipated by Fujii (6,771,586).

Regarding claim 9, Fujii teaches in figure 1 and related text a method of producing a compound semiconductor by growing on a GaAs substrate 1 InP crystal 9 or a compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs, which method of producing a compound semiconductor is characterized in that:

an InGaP buffer layer 14 or InGaAsP buffer layer is grown on a GaAs substrate 1; and

the InP crystal or a compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs 15 or 18 is grown on the InGaP buffer layer or InGaAsP buffer layer, wherein

the growth of the InGaP buffer layer or the InGaAsP buffer layer is conducted at a temperature of not lower than 400 °C and not higher than 600 °C to a thickness of not less than 5 nm and not greater than 500 nm, and

the growth of the InP crystal or a compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs is conducted at a temperature of not lower than 400 °C and not higher than 700 °C (column 6, lines 7-23).

Regarding claim 18, Fujii teaches in figure 1 and related text a method of producing a compound semiconductor, which comprises forming on a GaAs substrate 1 an InP crystal or a compound semiconductor crystal, wherein the compound semiconductor

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crystal has a lattice constant is closer to that of InP than that of GaAs 15 or 18, wherein the InP crystal or the compound semiconductor crystal is formed on the GaAs substrate via an InGaP buffer layer 14 or an InGaAsP buffer layer and the thickness of InGaP buffer layer or an InGaAsP buffer layer is not less than 5 nm and not greater than 300 nm (column 6, lines 7-23).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 10-17, as best understood, are rejected under 35 U.S.C. 103(a) as being unpatentable over Fujii.

Regarding claim 10, Fujii teaches substantially the entire claimed structure, as applied to the claims above, including the InP buffer layer is grown on the InGaP buffer layer or InGaAsP buffer layer.

Fujii does not explicitly state that the InP buffer layer is grown on the InGaP buffer layer or the InGaAsP buffer layer, the InP buffer layer is raised in temperature to a prescribed annealing temperature and annealed, and the temperature is lowered to a prescribed crystal growth temperature for growing the InP crystal or the compound semiconductor

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crystal whose lattice constant is closer to that of InP than that of GaAs, whereafter the InP crystal or the compound semiconductor crystal is grown.

It would have been obvious to a person of ordinary skill in the art at the time the invention was made to grow the InP buffer layer on the InGaP buffer layer or the InGaAsP buffer layer, wherein the InP buffer layer is raised in temperature to a prescribed annealing temperature and annealed, and the temperature is lowered to a prescribed crystal growth temperature for growing the InP crystal or the compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs, whereafter the InP crystal or the compound semiconductor crystal is grown, in Fujii's device, in order to improve the crystal quality of the layers.

Regarding claims 11-12, Fujii teaches in figure 1 and related text forming the InGaP buffer layer to a thickness of not less than 5 nm and not greater than 300 nm, forming the InP buffer layer to a thickness of not less than 20 nm and not greater than 200 nm, in prior art's device in order to reduce the size of the device.

Regarding claim 14, it would have been obvious to a person of ordinary skill in the art at the time the invention was made to form prior art's device by forming the InP buffer layer in temperature to a prescribed annealing temperature and annealed, and then, before growing the InP crystal or compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs, an operation for lowering the temperature from the prescribed annealing temperature to a prescribed crystal growth

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temperature and again raising it to the prescribed annealing temperature is repeated not less than one time and not more than five times, whereafter the temperature is lowered to the prescribed crystal growth temperature, in order to improve the crystal quality of the layers.

Regarding claims 15 and 16, it would have been obvious to a person of ordinary skill in the art at the time the invention was made to form prior art's device by using the prescribed annealing temperature not lower than 650 (or 400) °C and not higher than 730 (or 700) °C in order to have better control over the growth of the layers.

Regarding claim 17, it would have been obvious to a person of ordinary skill in the art at the time the invention was made to form the compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs or InGaAs or InAlAs crystal, in prior art's device, in order to improve the characteristics of the device.

Response to Arguments

Applicant's arguments with respect to claims 9-18 have been considered but are moot in view of the new ground(s) of rejection.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Ori Nadav whose telephone number is 571-272-1660. The examiner can normally be reached between the hours of 7 AM to 4 PM (Eastern Standard Time) Monday through Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Lynne Gurley can be reached on 571-272-1670. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

O.N.
12/21/2010

/ORI NADAV/
PRIMARY EXAMINER
TECHNOLOGY CENTER 2800